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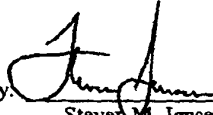
Docket No. 56386 (71987)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: C. Wu et al.
U.S.S.N.: 09/932,053 GROUP: 2823
FILED: August 18, 2001 EXAMINER: H. Lee
FOR: SEMICONDUCTOR PACKAGE AND FABRICATING METHOD
THEREOF

CERTIFICATE OF EXPRESS MAILING

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on this date July 14, 2003 in an envelope as "Express Mail Post Office to Addressee," mailing Label Number EV 343734903 US addressed to the: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

By: 
Steven M. Jensen

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

Applicants are in receipt of the Office Action dated March 12, 2003 of the above-referenced application. A Request for Continued Examination (RCE) and a one-month extension of time are filed herewith. Please amend the application as follows:

IN THE CLAIMS

Please amend claims 1 and 11 as follows:

Short

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